# Beam test of novel ASICs and sensors

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### Motivation



- In 2016 LHC will shutdown, during which BCM1 is planned to be replaced (GaAs?)
- R&D for FCal for ILC, CLIC (BeamCal/LumiCal)
- We joined the ongoing efforts to develop sensor and ASICs in the CMS/FCAL group at DESY





Compact Muon Solenoid





#### Senor and ASICs



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- All of the detectors are planned to be semiconductor, absorber sandwich calorimeters
- Prototype of sensors and front-end ASICs are available.
- For the first time sensors are connected to front-end ASICs









- Prove frontend electronics operation together with sensor and automated triggered readout in a particle beam.
- Collect experiences for preparation of a BCM1F/BeamCal/LumiCal prototype subset - plane or sector ('deliverable' within MC-PAD).

Taken from H. Henschel presentation 13 April Cracow



### Preparation of Test Beam



- Bonding ASICs and sensor.
- Remote control XY table.





#### Preparation of Test Beam



 Adapting software for readout device and DAQ.

 Integrating semi-online analisis in the DAQ system. Event no. 3 on 22 Jul 2010, 11:50 -- channel 0

ADC counts 1 10 п п 145 Signal Size Spectrum (pedestal not scaled) 140 45 Integration window 40 F 135 35 30 25 130 20 F Integration window 15 125 10 33000 33500 34000 32500 34500 120 Integrated charge [arb. unit] a a ra fa a a fa a ra fa a ra fa a a fa a a fa 100 200 300 400 500 600 700 800 t [ns]

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3.315e+04 778.3





#### Preparation of Test Beam

#### Using test pulses of 1V and attenuator we performed:

- We checked linearity of the ulletamplification of the ASICs
- Cross talk was observed during this test and was measured between four channels.











Test beam took place in beam line 22 of DESY II ring in Hamburg with 4.5 GeV electron beam. Measurements is the combination of our sensors, EUDET telescope and temperature



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### Eudet telescope



- 32X32 mm Si sensor
- 25µm strip pich
- 50µm strip readout







#### What we measured



- For each connected pad collected 4x50K events(cluster 2 and 4)
- Two high-statistic measurements (~2M events) for gaps between the peds
- We use broken bondings to measure cross talk.













 Because of different amplification used in the test beam, calibration measurment had to be done once again for all channels.









 Fitting was performed to covoluted gauss and landau distribution as a part of first analysis to calculate actual size of signal and to estimate signal to noise ratio and CCE and CCD for each spectrum ch7 Signal Size Spectrum (pedestal not scaled) ped. Entries 200100





#### 1 channel Cross talk



- The measured Hi-level cross talk may come from simultaneous feeding in four channels.
- One more input was made (cluster 1 pad 1) to measure this cross talk. As a result cross talk much lower than before.









- We collected more then 5M event on disk for 2 sensor (DAQ &Telescope) during the 2 weeks of test beam.
- Next step is to combine data from TELEna with our DAQ for complete analysis .

## Thank you for your attention

